

# N-Channel 30-V (D-S) MOSFET

PRODUCT SUMMARY					
V <sub>DS</sub> (V)	R <sub>DS(on)</sub> (Ω)	I <sub>D</sub> (A) <sup>a</sup>	Q <sub>g</sub> (Typ.)		
30	0.030 at V <sub>GS</sub> = 10 V	6.5	4.5 nC		
50	0.033 at V <sub>GS</sub> = 4.5 V	6.0	4.5110		

### **FEATURES**

- Halogen-free According to IEC 61249-2-21
   Definition
- TrenchFET<sup>®</sup> Power MOSFET

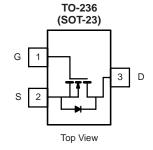
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- 100 % R<sub>g</sub> Tested
- Compliant to RoHS Directive 2002/95/EC

### **APPLICATIONS**

DC/DC Converter





#### S N-Channel MOSFET

Parameter		Symbol	Limit	Unit	
Drain-Source Voltage		V <sub>DS</sub>	30	V	
Gate-Source Voltage		V <sub>GS</sub>	± 20		
	T <sub>C</sub> = 25 °C		6.5 <sup>a</sup>		
Continuous Drain Current ( $T_1 = 150 \ ^{\circ}C$ )	T <sub>C</sub> = 70 °C	1 . [	6.0		
Continuous Drain Current (1) = 150°C)	T <sub>A</sub> = 25 °C	I <sub>D</sub>	5.3		
	T <sub>A</sub> = 70 °C	1 1	5.0	A	
Pulsed Drain Current		I <sub>DM</sub>	25		
	T <sub>C</sub> = 25 °C		1.4		
Continuous Source-Drain Diode Current	T <sub>A</sub> = 25 °C	ا <sub>S</sub>	0.9 <sup>b, c</sup>		
	T <sub>C</sub> = 25 °C		1.7		
Maximum Power Dissipation	T <sub>C</sub> = 70 °C	P <sub>D</sub>	1.1	w	
	T <sub>A</sub> = 25 °C	טי ן	1.1 <sup>b, c</sup>	vv	
	T <sub>A</sub> = 70 °C	1 [	0.7 <sup>b, c</sup>		
Operating Junction and Storage Temperature Range		T <sub>J</sub> , T <sub>stg</sub>	- 55 to 150	°C	
Soldering Recommendations (Peak Temperature) <sup>d, e</sup>			260		

THERMAL RESISTANCE RATINGS						
Parameter		Symbol	Typical	Maximum	Unit	
Maximum Junction-to-Ambient <sup>b, d</sup>	t ≤ 5 s	R <sub>thJA</sub>	90	115	°C/W	
Maximum Junction-to-Foot (Drain)	Steady State	R <sub>thJF</sub>	60	75	0/11	

Notes:

a. Package limited

b. Surface Mounted on 1" x 1" FR4 board.

c. t = 5 s.

d. Maximum under steady state conditions is 130 °C/W.

Test Conditions $_{S} = 0 \text{ V}, \text{ I}_{D} = 250 \mu\text{A}$ $_{I_{D}} = 250 \mu\text{A}$ $_{S} = \text{V}_{GS}, \text{ I}_{D} = 250 \mu\text{A}$ $_{S} = 0 \text{V}, \text{V}_{GS} = \pm 20 \text{V}$ $_{S} = 30 \text{V}, \text{V}_{GS} = 0 \text{V}$ $_{O} \text{V},  $	Min.           30           0.7	Typ.           31           - 5           1.1	2.0	V W WV/°C	
$I_{D} = 250 \ \mu A$ $S = V_{GS}, I_{D} = 250 \ \mu A$ $S = 0 \ V, V_{GS} = \pm 20 \ V$ $S = 30 \ V, V_{GS} = 0 \ V$ $V_{GS} = 0 \ V, T_{J} = 55 \ ^{\circ}C$		- 5	2.0		
$I_{D} = 250 \ \mu A$ $S = V_{GS}, I_{D} = 250 \ \mu A$ $S = 0 \ V, V_{GS} = \pm 20 \ V$ $S = 30 \ V, V_{GS} = 0 \ V$ $V_{GS} = 0 \ V, T_{J} = 55 \ ^{\circ}C$		- 5	2.0		
$I_{S} = V_{GS}$ , $I_{D} = 250 \ \mu A$ $I_{S} = 0 \ V$ , $V_{GS} = \pm 20 \ V$ $I_{S} = 30 \ V$ , $V_{GS} = 0 \ V$ $0 \ V$ , $V_{GS} = 0 \ V$ , $T_{J} = 55 \ ^{\circ}C$	0.7	- 5	2.0	mV/°0	
$V_{S} = 0 V, V_{GS} = \pm 20 V$ $V_{S} = 30 V, V_{GS} = 0 V$ $V, V_{GS} = 0 V, T_{J} = 55 °C$	0.7	-	2.0	mV/°C	
$V_{S} = 0 V, V_{GS} = \pm 20 V$ $V_{S} = 30 V, V_{GS} = 0 V$ $V, V_{GS} = 0 V, T_{J} = 55 °C$	0.7	1.1	20		
$_{\rm S}$ = 30 V, V <sub>GS</sub> = 0 V 0 V, V <sub>GS</sub> = 0 V, T <sub>J</sub> = 55 °C				V	
) V, V <sub>GS</sub> = 0 V, T <sub>J</sub> = 55 °C			± 100	nA	
			1	μA	
$_{\rm S}$ $\geq$ 5 V, V <sub>GS</sub> = 10 V			10	<u> </u>	
	10			A	
<sub>SS</sub> = 10 V, I <sub>D</sub> = 3.2 A		0.030		Ω	
<sub>S</sub> = 4.5 V, I <sub>D</sub> = 2.8 A		0.033		52	
<sub>oS</sub> = 15 V, I <sub>D</sub> = 4.8 A		11		S	
		335			
$V_{DS}$ = 15 V, $V_{GS}$ = 0 V, f = 1 MHz		45		pF	
		17			
5 V, V <sub>GS</sub> = 10 V, I <sub>D</sub> = 3.4 A		4.5	6.7	-	
		2.1	3.2		
V <sub>DS</sub> = 15 V, V <sub>GS</sub> = 4.5 V, I <sub>D</sub> = 3.4 A		0.85		nC	
		0.65		1	
f = 1 MHz	0.8	4.4	8.8	Ω	
		12	20		
$V_{DD}$ = 15 V, R <sub>L</sub> = 5.6 $\Omega$ I <sub>D</sub> $\cong$ 2.7 A, V <sub>GEN</sub> = 4.5 V, R <sub>g</sub> = 1 $\Omega$		50	75	-	
		12	20		
-		22	35	1	
		5	10	ns	
$V_{DD}$ = 15 V, R <sub>L</sub> = 5.6 Ω I <sub>D</sub> ≅ 2.7 A, V <sub>GEN</sub> = 10 V, R <sub>g</sub> = 1 Ω		12	20		
		10	15		
		5	10		
T <sub>C</sub> = 25 °C			1.4		
•			15	A	
= 2.7 A, V <sub>GS</sub> = 0 V		0.8		V	
, 00 -	1			ns	
-				nC	
	<u> </u>		10		
dl/dt = 100 A/µs, T <sub>J</sub> = 25 °C				ns	
	= 2.7 A, V <sub>GS</sub> = 0 V dl/dt = 100 A/µs, T <sub>J</sub> = 25 °C		10	$= 2.7 \text{ A}, \text{ V}_{\text{GS}} = 0 \text{ V} \qquad 0.8 \qquad 1.2$ $10 \qquad 20$ $dI/dt = 100 \text{ A}/\mu\text{s}, \text{ T}_{\text{J}} = 25 \text{ °C} \qquad 5 \qquad 10$ $6$	

Notes:

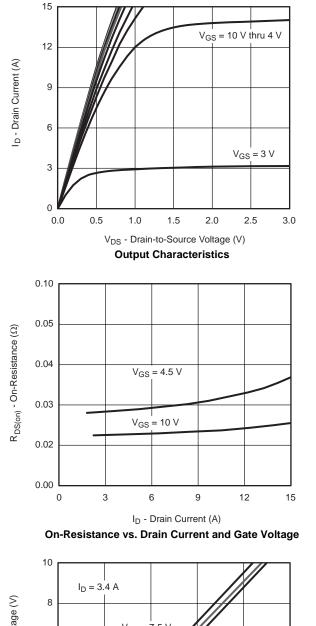
a. Pulse test; pulse width  $\leq$  300  $\mu s,$  duty cycle  $\leq$  2 %

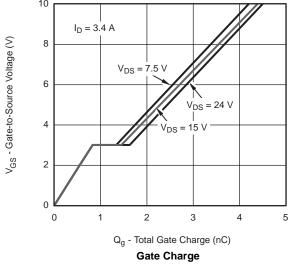
b. Guaranteed by design, not subject to production testing.

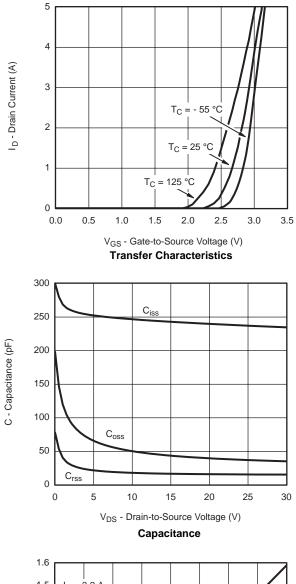
Stresses beyond those listed under "Absolute Maximum Ratings" may cause permanent damage to the device. These are stress ratings only, and functional operation of the device at these or any other conditions beyond those indicated in the operational sections of the specifications is not implied. Exposure to absolute maximum rating conditions for extended periods may affect device reliability.

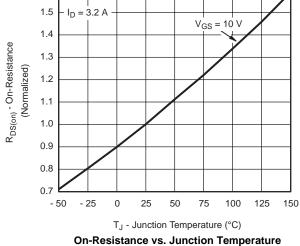
VBsemi Bsemi.com



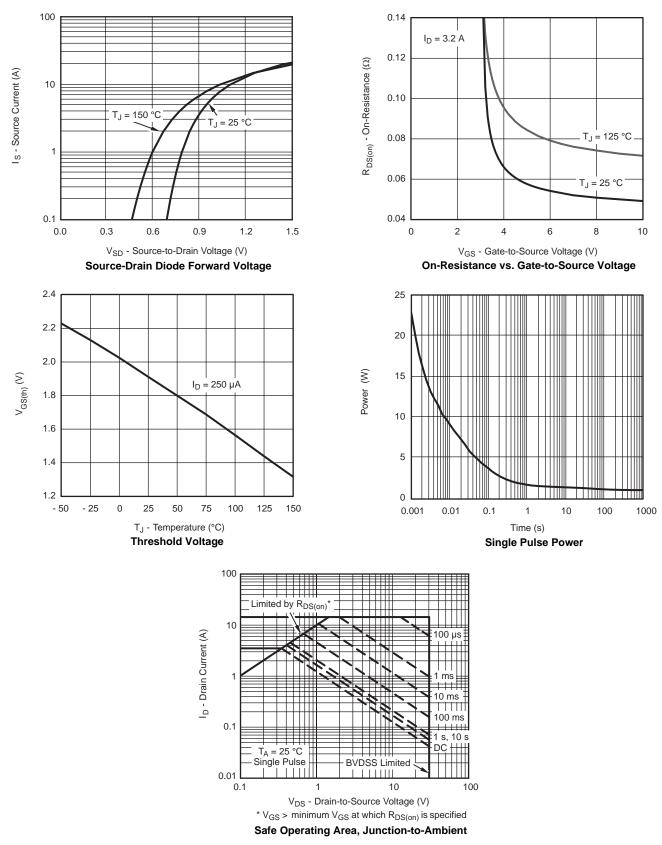




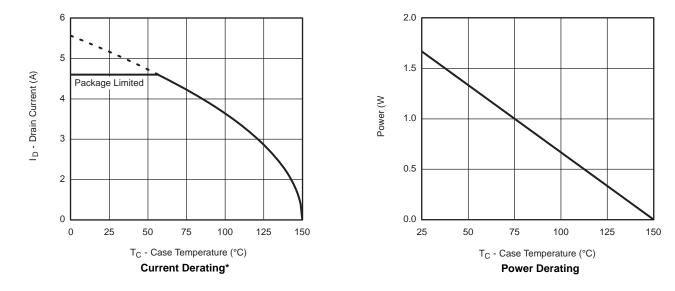






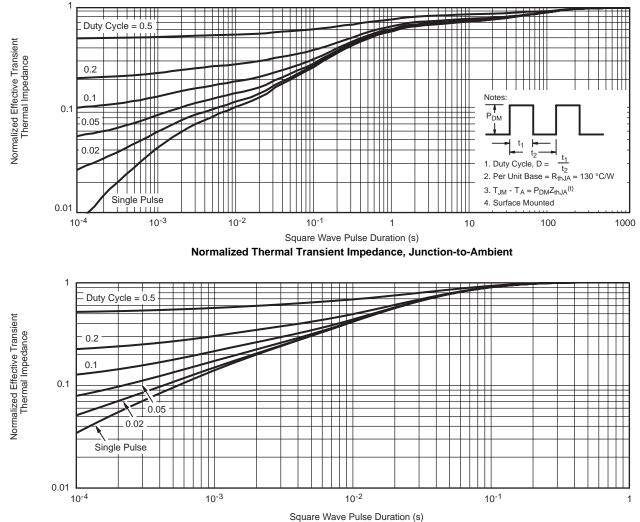






\* The power dissipation  $P_D$  is based on  $T_{J(max)}$  = 150 °C, using junction-to-case thermal resistance, and is more useful in settling the upper dissipation limit for cases where additional heatsinking is used. It is used to determine the current rating, when this rating falls below the package limit.





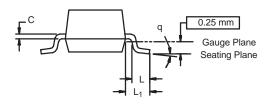
Normalized Thermal Transient Impedance, Junction-to-Foot



# SOT-23 (TO-236): 3-LEAD







Dim	MILLIN	<b>METERS</b>	INCHES		
	Min	Max	Min	Max	
Α	0.89	1.12	0.035	0.044	
A <sub>1</sub>	0.01	0.10	0.0004	0.004	
A <sub>2</sub>	0.88	1.02	0.0346	0.040	
b	0.35	0.50	0.014	0.020	
С	0.085	0.18	0.003	0.007	
D	2.80	3.04	0.110	0.120	
E	2.10	2.64	0.083	0.104	
E <sub>1</sub>	1.20	1.40	0.047	0.055	
е	0.95 BSC		0.0374 Ref		
e <sub>1</sub>	1.90 BSC		0.0748 Ref		
L	0.40	0.60	0.016	0.024	
L <sub>1</sub>	0.64 Ref		0.025 Ref		
S	0.50 Ref		0.020 Ref		
q	3°	8°	3°	8°	
ECN: S-03946-Rev. K, 09- DWG: 5479	Jul-01				



## **RECOMMENDED MINIMUM PADS FOR SOT-23**



Recommended Minimum Pads Dimensions in Inches/(mm)

Return to Index



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